

MOSFET

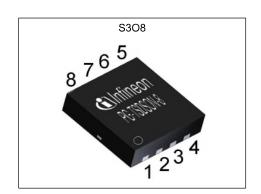
OptiMOS™3 M-Series Power-MOSFET, 30 V

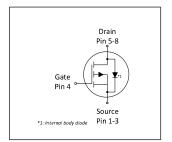
Features

- Optimized for 5V driver application (Notebook, VGA, POL)
- Low FOMQ_{SW} for high frequency SMPS
 100% avalanche tested
- N-channel
- Very low on-resistance $R_{\rm DS(on)}$ @ $V_{\rm GS}$ =4.5 V
- Excellent gate charge x R_{DS(on)} product (FOM)
 Qualified according to JEDEC¹⁾ for target applications
 Superior thermal resistance
- Pb-free plating; RoHS compliant
- Halogen-free according to IEC61249-2-21



Parameter	Value	Unit					
V _{DS}	30	V					
R _{DS(on),max} (V _{GS} =10 V)	9.1	m $Ω$					
R _{DS(on),max} (V _{GS} =4.5 V)	11.4	m $Ω$					
I _D	44	A					











Type / Ordering Code	Package	Marking	Related Links
BSZ100N03MS G	PG-TSDSON-8	100N03M	-

OptiMOS™3 M-Series Power-MOSFET, 30 V BSZ100N03MS G



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Parameter	0 1 1		Value	s		
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	l _D	- - - -	- - - -	44 28 39 25 10	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 K/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	176	Α	<i>T</i> _C =25 °C
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	20	Α	T _C =25 °C
Avalanche energy, single pulse	E _{AS}	-	-	15	mJ	$I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	30 2.1	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 K/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

2 Thermal characteristics

Table 3 **Thermal characteristics**

Davamatar	Cymbal	Values			l lmi4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	_	4.1	K/W	-
Device on PCB, 6 cm² cooling area²)	R_{thJA}	_	_	60	K/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions. ²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See figure 3 for more detailed information⁴⁾ See figure 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Damamatan	Course to a l		Values			Nada / Taad Can didian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	30	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.0	-	2.0	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=250\ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10.0	1.0 100.0	μA	V _{DS} =30 V, V _{GS} =0 V, T _j =25 °C V _{DS} =30 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =16 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	9.5 7.3	11.4 9.1	mΩ	V_{GS} =4.5 V, I_{D} =20 A V_{GS} =10 V, I_{D} =20 A
Gate resistance	R _G	0.4	0.9	1.6	Ω	-
Transconductance	g_{fs}	26	52	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 30 \text{ A}$

 Table 5
 Dynamic characteristics

Davamatav	Comple ed	Values			l lmit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	C _{iss}	-	1300	1700	pF	V _{GS} =0 V, V _{DS} =15 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	440	590	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Reverse transfer capacitance	C _{rss}	-	27	-	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	3.8	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G}$ =1.6 Ω
Rise time	t _r	-	2.8	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	16	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G}$ =1.6 Ω
Fall time	t _f	-	2.4	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Davamatav	Cumbal	Values			11!4	Nata / Tast Canditian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge ¹⁾	Q_{gs}	-	4.3	5.8	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate charge at threshold ¹⁾	$Q_{g(th)}$	-	2.1	2.8	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	2.0	3.3	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Switching charge ¹⁾	Q _{sw}	-	4.2	6.2	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	8.3	11	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	3.3	-	V	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	17	23	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 10 V
Gate charge total, sync. FET ¹⁾	Q _{g(sync)}	-	7.2	9.6	nC	V_{DS} =0.1 V, V_{GS} =0 to 4.5 V
Output charge ¹⁾	Qoss	-	12	15	nC	V _{DD} =15 V, V _{GS} =0 V

Defined by design. Not subjected to production test See "gate charge waveforms" for parameter definition

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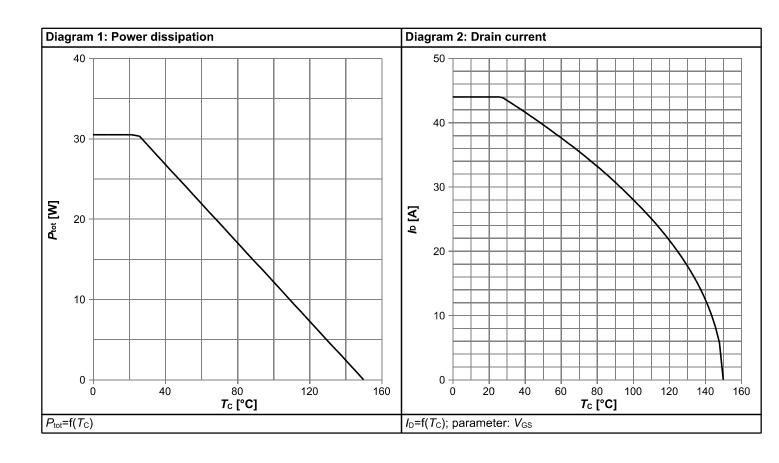


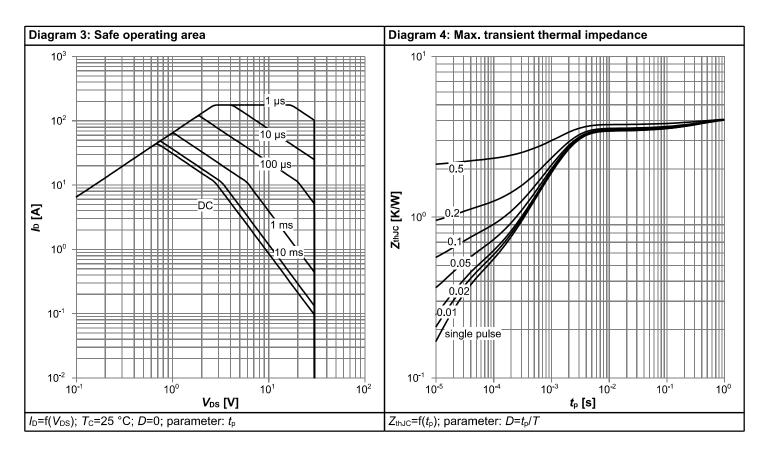
Table 7 Reverse diode

Davamatav	Comple of	Values			11:4	Nata / Tank Canadikian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	28	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	176	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.88	1.1	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery charge	Q _{rr}	-	-	10	nC	V _R =15 V, I _F =I _S , di _F /dt=400 A/μs

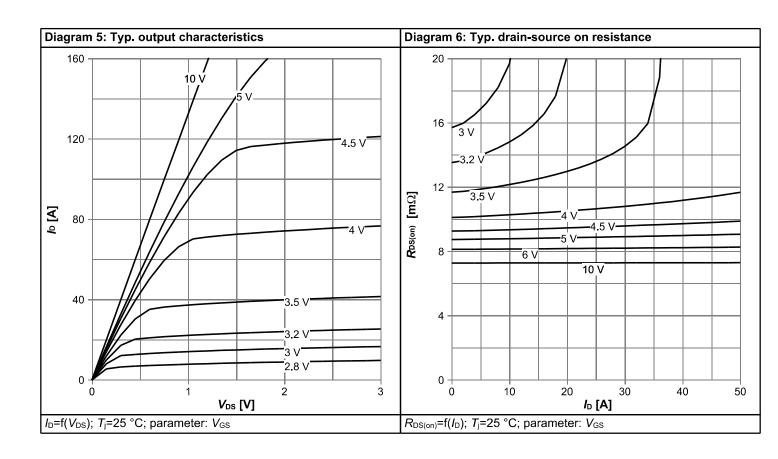


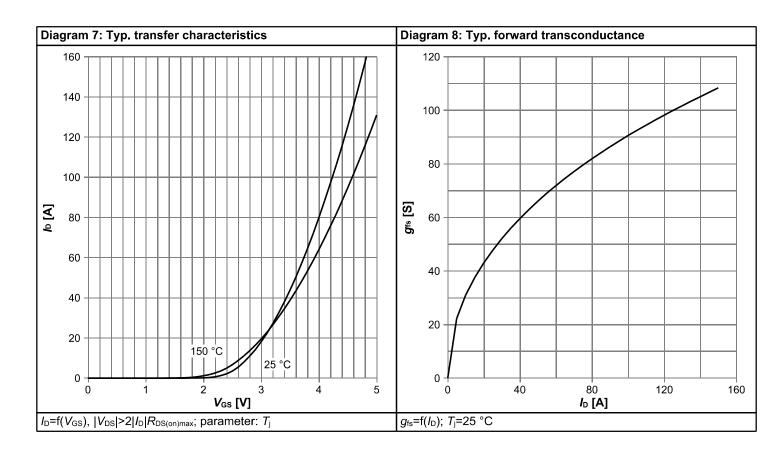
4 Electrical characteristics diagrams



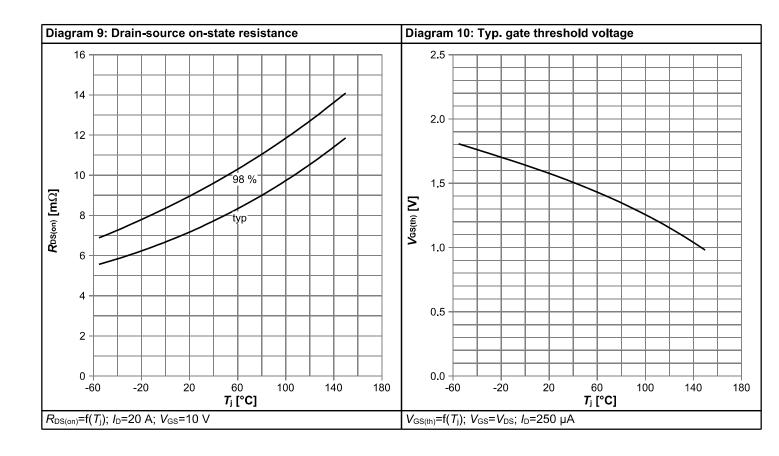


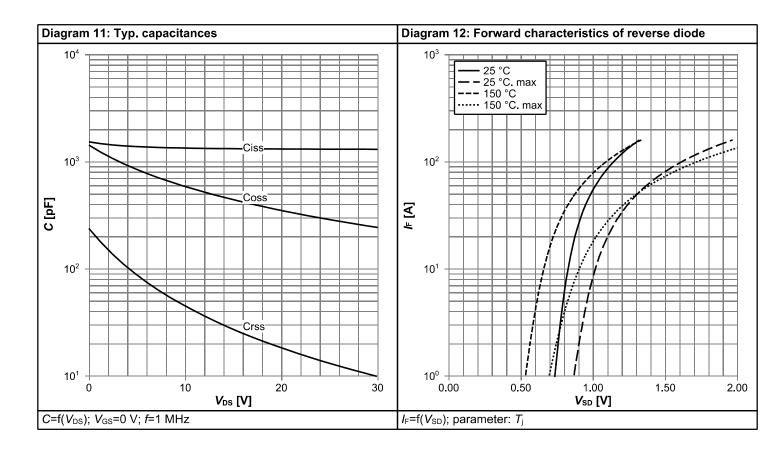




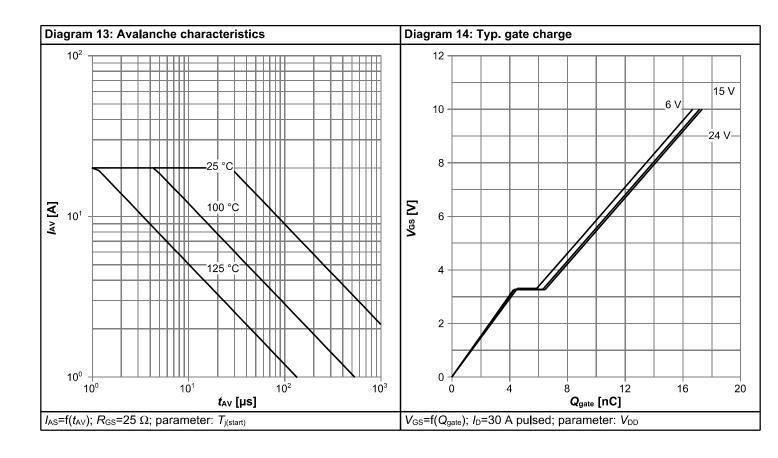


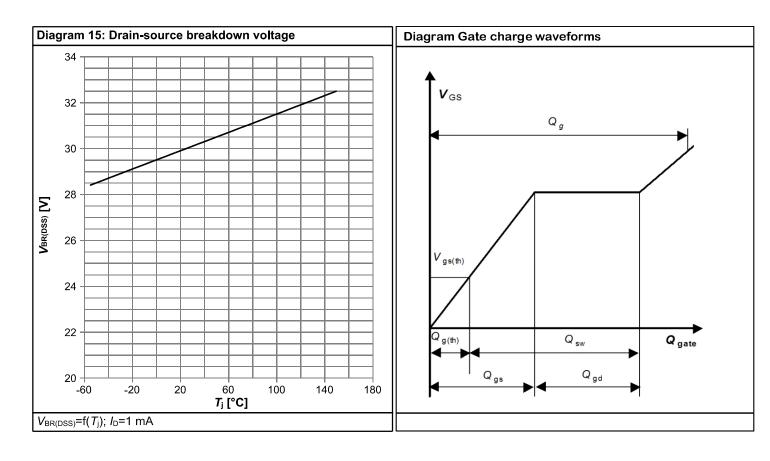






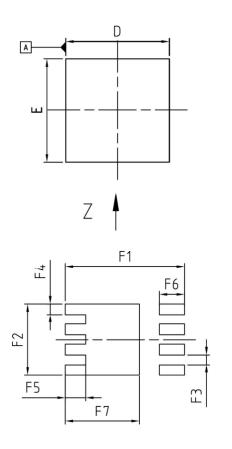


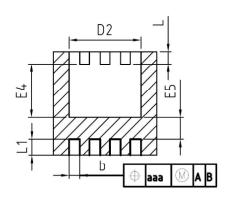


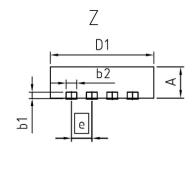




5 Package Outlines







INCHES				
X				
43				
17				
12				
17				
34				
96				
34				
71				
34				
0.026				
22				
24				
0.010				
0.150				
0.013				
0.031				

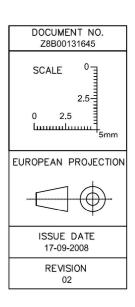


Figure 1 Outline PG-TSDSON-8, dimensions in mm/inches

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Revision History

BSZ100N03MS G

Revision: 2021-07-20, Rev. 2.1

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.1	2021-07-20	Update Id Max current rating

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